Status of Outer Tracker Modules and Sensors



Tim Nelson - SLAC SiD workshop - 10/26/06

Module Components

~IOcm

KPÍX Chíps, bump-bonded

Square, Single-sided Si Sensor from 6" wafer

> CF/Rohacell support frame

_10cm

Power/readout Cable, glued/wirebonded

Sensors

- Prototype design shown at vancouver has been detailed at FNAL
- Will have review of design and specs in next few weeks
- Anticipate delivery from HPK Spring 2007





KPiX

- KPÍX3-64, most recent prototype: see Davíd Strom's talk
- KPÍX4-64 will include nearest-neighbor logic for tracker use
- Anticipate KPIX-1024 during first half 2007



Support

Modifications that accommodate final design of prototype sensors underway

Plan to have support frames/clips rapidprototyped to test mounting concept



Cables

- Significant
 progress on KPiX
 cables for ECAL
- Modification of finished design for tracker should be straightforward





Conclusions

Progress being made on the critical components for modules

On track to produce a complete module prototype in 2007